

I S O • I A T F 1 6 9 4 9 CERTIFICATE LIST

[Date of issue] 6th/Sep/2024

| ISO9001:2015 | Certificate date | Certificate body / Certificate No. | Goods or services in respect of which the film is registered |
|---|----------------------------------|--|---|
| ROHM Co.,Ltd. WP Production Headquarters Kyoto WP Production Division (Formerly ROHM Co.,Ltd. LSI Headquarters) | ('94. 3.31)/'24. 7. 4/'27. 7. 3 | J Q A JQA-0464 | THE PROCESS DESIGN/DEVELOPMENT AND MANUFACTURE OF WAFER FOR SEMICONDUCTOR INTEGRATED CIRCUIT. |
| ROHM Wako Co.,Ltd. | ('01. 6.22)/'24. 1.18/'27. 1.17 | J Q A JQA-QM6714 | THE MANUFACTURE OF WAFER OF DIODES AND POWER LSIS. THE MANUFACTURE OF DIODES, LASER DIODES, SENSOR AND LED |
| ROHM Apollo Co.,Ltd. | | | |
| ROHM Apollo Co.,Ltd. Yukuhashi Plant | ('94. 5.16)/'21.12.21/'24.12.20 | J Q A JQA-0494 | PRODUCTION OF MONOLITHIC ICs. |
| ROHM Apollo Co.,Ltd. Chikugo Plant | ('97. 6.13)/'24. 6.16/'27. 6.15 | J Q A JQA-1769 | MANUFACTURING OF DISCRETE WAFERS, LSI WAFERS AND SILICON WAFERS |
| ROHM Apollo Co.,Ltd. Hirokawa Plant | ('94.11.11)/'24. 7.10/'27. 7. 9 | J Q A JQA-0667 | THE MANUFACTURE OF TRANSISTOR, DIODE, POWER MODULE , OPTICAL MODULE, RESISTOR AND PRINT HEAD |
| ROHM Hamamatsu Co.,Ltd. | ('00. 4.28)/'24. 8.29/'27. 8.28 | J Q A JQA-QM4732 | MANUFACTURING OF WAFER FOR SEMICONDUCTOR AND SEMICONDUCTOR INTEGRATED CIRCUIT |
| ROHM Mechatech Co.,Ltd. | ('02. 3.15)/'22. 3.26/'25. 3.25 | J Q A JQA-QM7968 | ·DESIGN/DEVELOPMENT AND MANUFACTURE OF DIES. ·THE DESIGN/DEVELOPMENT AND MANUFACTURE OF LEAD FRAMES. |
| LAPIS Semiconductor Co.,Ltd. | ('94. 4.25)/'24. 9. 6/'27. 9. 5 | J Q A JQA-0478 | THE MANUFACTURE OF SEMICONDUCTOR INTEGRATED CIRCUIT DEVICES AND MODULES. THE MANUFACTURE OF DISCRETE DEVICES. |
| ROHM Co.,Ltd. Shiga Plant (Formerly ROHM Shiga Co., Ltd.) | ('17. 8.10)/'21.11. 9/'24.11. 8 | J Q A JQA-QMA15627 | THE PRODUCTION OF SEMICONDUCTOR DEVICE WAFER |
| ROHM Korea Corporation | ('94. 8.30)/'24. 6.14/'27. 6.13 | D N V ·GL C642640 | MANUFACTURE OF DIODES, TRANSISTORS AND INTEGRATED CIRCUITS. |
| ROHM Electronics Philippines, Inc. | ('94.12. 9)/'24. 5.18/'27. 5.17 | T U V 01 100 075077 | MANUFACTURING OF MICROCHIP RESISTORS(MCR), MONOLITHIC INTEGRATED CIRCUITS(LSI), TRANSISTORS(TR), and DIODES(DI); PROVISION OF LABORATORY SERVICES |
| ROHM Semiconductor (China) Co.,Ltd. | ('04.12.30)/'23. 7.27/'26. 7.26 | S G S CN04/0676 | MANUFACTURE OF DIODES, LIGHT-EMITTING DIODES(LED), DISPLAYS, SENSORS AND LASER DIODES |
| ROHM Electronics Dalian Co.,Ltd. | ('03. 7. 8)/'24. 6.27/'27. 7. 5 | C Q C 00124Q35416R7M/2100 | PRODUCTION OF THERMAL PRINT HEAD(PH) & FUNCTION MODULE(PM,OPM) |
| ROHM Integrated Systems (Thailand) Co.,Ltd. | ('95.12.22)/'24. 8.29/'27. 8.28 | J Q A JQA-1095 | THE MANUFACTURE OF TRANSISTORS,DIODES,RESISTORS,MONOLITHIC INTEGRATED CIRCUITS(ICs),TANTALUM CAPACITORS,OPTICAL MODULE AND INTELLIGENT POWER MODULES(IPMs) |
| ROHM Electronics (Malaysia) Sdn.Bhd. | ('98. 2.27)/'24. 8. 9/'27. 8. 8 | J Q A JQA-2181 | THE MANUFACTURE OF DIODES AND LIGHT EMITTING DIODES. |
| ROHM Mechatech Philippines, Inc. | ('05. 1.26)/'24. 7.19/'27. 7.18 | T U V 44 100 082110 | DESIGN AND MANUFACTURING OF LEADFRAMES AND PRECISION TOOLINGS AND RELATED PARTS |
| ROHM Mechatech (Thailand) Co.,Ltd. | ('14. 1.17)/'21.12.21/'24.12.20 | J Q A JQA-QMA14948 | ·THE MANUFACTURE OF LEAD FRAMES ·THE MANUFACTURE, MODIFICATION AND REPAIR OF MOULD SETS AS WELL AS THEIR PARTS ·THE MANUFACTURE OF STEM PARTS FOR LASER DIODES |
| SiCrystal GmbH | ('23. 8.31)/ - /'26. 8.30 | T U V TIC 15100117579 | Development,manufacturing and distribution of silicon carbide substrates |
| IATF16949:2016 | Certificate date | Certificate body / Certificate No. Certificate IATF No. | Goods or services in respect of which the film is registered |
| ROHM Co.,Ltd. WP Production Headquarters Kyoto WP Production Division (Formerly ROHM Co.,Ltd. LSI Headquarters) | ('18. 7. 4)/'24. 6.28/'27. 6.27 | J Q A JQA-AU0337 0526653 | DESIGN AND MANUFACTURING OF WAFER FOR SEMICONDUCTOR INTEGRATED CIRCUIT. |
| ROHM Co.,Ltd. Module Business Unit Module WP Control Department | ('22. 7.22)/'23. 7. 7 /'25. 7.21 | J Q A JQA-AU0439 0454229 | ·DESIGN AND MANUFACTURING OF LASER DIODE WAFER ·DESIGN AND MANUFACTURING OF LED WAFER (Expanding the scope of certification) |
| ROHM Wako Co.,Ltd. | ('04.12.10)/'24. 1.12/'27. 1.11 | J Q A JQA-AU0074 0406980 | DESIGN AND MANUFACTURING OF WAFER OF DIODES AND WAFER OF POWER LSIS DESIGN AND MANUFACTURING OF DIODES AND LASER DIODES |
| ROHM Apollo Co.,Ltd. Yukuhashi Plant | ('18.12.21)/'22.12. 9/'24.12. 7 | J Q A JQA-AU0351 0437118 | DESIGN AND MANUFACTURING OF LSI |
| ROHM Apollo Co.,Ltd. Chikugo Plant | ('05. 6.24)/'24. 5.31/'27. 5.30 | J Q A JQA-AU0092 0520323 | DESIGN AND MANUFACTURING OF DISCRETE WAFERS AND LSI WAFERS |
| ROHM Apollo Co.,Ltd. Hirokawa Plant | ('16. 8.26)/'24. 9. 6/'27. 9. 5 | J Q A JQA-AU0307 0543102 | DESIGN AND MANUFACTURING OF OPTICAL MODULE, POWER TRANSISTOR AND DIODES |
| ROHM Hamamatsu Co.,Ltd. | ('11. 7. 8)/'24. 8.30/'27. 8.29 | J Q A JQA-AU0231 0541391 | DESIGN AND MANUFACTURING OF WAFER FOR SEMICONDUCTOR AND SEMICONDUCTOR INTEGRATED CIRCUIT. |
| LAPIS Semiconductor Co.,Ltd. Miyazaki Plant (Formerly LAPIS Semiconductor Miyazaki Co.,Ltd.) | ('13.10.11)/'24. 8.15/'27. 8.14 | J Q A JQA-AU0259-1 0537976 | DESIGN AND MANUFACTURING OF SEMICONDUCTOR INTEGRATED CIRCUIT DEVICES AND DISCRETE DEVICES |
| LAPIS Semiconductor Co.,Ltd. Miyagi Plant (Formerly LAPIS Semiconductor Miyagi Co.,Ltd.) | ('13.10.11)/'24. 8.15/'27. 8.14 | J Q A JQA-AU0259-2 0537985 | DESIGN AND MANUFACTURING OF SEMICONDUCTOR INTEGRATED CIRCUIT DEVICES |
| ROHM Co.,Ltd. Shiga Plant (Formerly ROHM Shiga Co., Ltd.) | ('13.11. 9)/'23.10.20 /'24.11.10 | J Q A JQA-AU0347 0433932 | DESIGN AND MANUFACTURING OF SEMICONDUCTOR DEVICE WAFER |
| ROHM Korea Corporation | ('94. 8.30)/'24. 6.14/'27. 6.13 | D N V 10162-2005-AQ-HOU-IATF 0523599 | DESIGN AND MANUFACTURE OF HIGH POWER DEVICE, DIODES AND TRANSISTORS |
| ROHM Electronics Philippines, Inc. | ('07. 6. 4)/'24. 5.11/'27. 5.10 | T U V 01 111 075077 0399322 | DESIGN AND MANUFACTURING OF MICROCHIP RESISTORS(MCR), MONOLITHIC INTEGRATED CIRCUITS(LSI), TRANSISTORS(TR), and DIODES(DI) |
| ROHM Integrated Systems (Thailand) Co.,Ltd. | ('05. 4.28)/'24. 8.30/'27. 8.29 | J Q A JQA-AU0090 0541392 | DESIGN AND MANUFACTURING OF TRANSISTORS, DIODES, RESISTORS, MONOLITHIC INTEGRATED CIRCUITS(ICs) AND INTELLIGENT POWER MODULES(IPMs) |
| ROHM Electronics (Malaysia) Sdn.Bhd. | ('06. 3. 3)/'24. 7.19/'27. 7.18 | J Q A JQA-AU0112 0531474 | DESIGN AND MANUFACTURING OF DIODES AND LIGHT EMITTING DIODES. |
| ROHM Semiconductor (China) Co.,Ltd. | ('06. 3. 6)/'24. 8.20/'27. 8.19 | S G S CN06/11069 0540160 | DESIGN AND MANUFACTURE OF DIODES, LIGHT EMITTING DIODES AND SENSORS |
| ROHM Mechatech Philippines, Inc. | ('17.12.16)/'24. 5. 5/'27. 5. 4 | T U V 44 111 141260 0515063 | DESIGN AND MANUFACTURING OF LEAD FRAME FOR ELECTRONIC COMPONENTS |
| ROHM Mechatech (Thailand) Co.,Ltd. | ('18.12.21)/'22. 1.21/'25. 1.20 | J Q A JQA-AU0350 0441693 | DESIGN AND MANUFACTURING OF LEAD FRAMES |
| ISO26262:2018 | Certificate date | Certificate body / Certificate No. | Goods or services in respect of which the film is registered |
| ROHM Co.,Ltd. | ('18. 3.21)/'22.10.28/'24. 7.20 | T U V 968/A-FSM 113.03/21 | DESIGN / DEVELOPMENT AND MANUFACTURE OF INTEGRATED CIRCUIT. (ISO 26262-2:2018,ISO 26262-4:2018,ISO 26262-5:2018,ISO 26262-6:2018, ISO 26262-7:2018,ISO 26262-8:2018,ISO 26262-9:2018,ISO 26262-11:2018) |

·ISO9001 :Quality management systems
·IATF16949 : Automotive Quality Management System Standard
·ISO26262 :International standard for functional safety of electrical and/or electronic systems in production automobiles.

※ISO/IEC17025 (General requirements for the competence of testing and calibration laboratories) : Delete registration
 ※IATF16949 ROHM Electronics Dalian Co.,Ltd. : Withdrawal of certification[DESIGN AND MANUFACTURE OF OPTICAL MODULE (INFRARED RECEIVER MODULE)] (14th/Dec/2023)
 ※Company name change of ROHM-Wako Electronics (Malaysia) Sdn.Bhd.⇒New company name: ROHM Electronics (Malaysia) Sdn.Bhd. (2nd/Jan/2024)
 ※SiCrystal GmbH : Acquiring new ISO9001 certification
 ※Kionix,Inc. : Withdrawal of ISO9001 certification (by merging Kionix,Inc. with ROHM USA,Inc.)
 ※Due to LAPIS Technology's merger with ROHM, LAPIS Technology's ISO9001 certification was removed. (Effective April 1st, 2024)
 ※Due to ROHM Logistec's merger with ROHM Wako, ROHM Logistec's ISO9001 certification was removed. (Effective June 14th, 2024)

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This certification acquisition list is as of the issue date. Please contact our sales representative for the latest information